



Enea and CEVA Announce Enea OSEck Real-Time Operating System for CEVA-X and CEVA-TeakLite-III DSP Architectures

Stockholm, Sweden, and San Jose, Calif., – June 4, 2008 – Enea (Nordic Exchange/Small Cap/ENEAA), a world leading provider of network software and services and CEVA, Inc. (NASDAQ: CEVA); (LSE: CVA), a leading licensor of silicon intellectual property (SIP) platform solutions and DSP cores, today announced the availability of the Enea OSEck real-time operating system for two CEVA DSP architectures: the CEVA-TeakLite-III and the CEVA-X. These two low-power, high-performance DSP architectures, together with Enea OSEck, provide an ideal platform for a broad range of multimedia and wireless baseband applications, including high-definition audio, portable media players, 3G and 4G mobile handsets and VoIP residential gateways.

"Today's converged multimedia consumer devices require an enormous amount of signal processing capability," said Terry Pearson, vice president of marketing at Enea. "But they also have severe cost and power constraints. The CEVA cores deliver unprecedented signal processing performance with low power consumption. Enea OSEck's small footprint, nimble real-time response, and high-level programming environment makes it ideal for developing and deploying complex signal processing applications targeting CEVA's processors."

"Our CEVA-TeakLite-III and CEVA-X DSP architectures set a new standard for scalable, low-power, high-performance, signal processing," said Eyal Ben-Avraham, vice president, Strategic Accounts & Partners at CEVA. "Enea OSEck provides a proven real-time architecture that has already shipped in millions of devices worldwide. Its small code size and memory footprint, coupled with its intuitive messaging architecture and support for high-level languages like C, make it an attractive platform for developing and hosting CEVA-based multimedia and baseband applications."

CEVA-TeakLite-III(TM) is a third-generation DSP architecture based on the broadly adopted TeakLite family of DSP cores. Featuring native 32-bit processing and a dual Multiply-Accumulate (MAC) architecture, CEVA-TeakLite-III cores are ideal for High Definition (HD) audio applications such as Dolby Digital Plus 7.1, Dolby TrueHD and DTS-HD. The cores are also ideal for cost-sensitive consumer products such as 2G/2.5G/3G wireless baseband modems, wideband voice and audio processors, portable media players, voice-over-IP residential gateways and dual mode cellular/voice-over-WiFi handsets.

CEVA-X is a scalable VLIW-SIMD DSP architecture that delivers high levels of performance with low power consumption. CEVA-X is a multipurpose architecture, supporting multiple derivative cores that can be optimized to meet the performance, price, and power requirements of specific applications such as 3G and 4G phones, Smartphones, Personal Media Players and infrastructure equipment. The CEVA-X architecture can be extended with user-defined instructions. It is also scalable, supporting from 2 to 16 MAC units with added computational resources and memory bandwidth.

Enea OSEck (OSE Compact Kernel) is a DSP-optimized version of Enea's full-featured OSE RTOS. Occupying as little as 8 kbytes of memory, OSEck delivers fully-preemptive, event-driven real-time response and features built-in error detection and handling. This combination makes OSEck ideal for telecom, datacom, automotive, industrial control, medical and mil/aero applications with tight memory constraints that require reliable real-time control and signal processing.

Like all members of the Enea OSE family, Enea OSEck employs a high-level message passing programming model that makes it easy to break complex applications into simpler concurrent processes, each communicating via high-speed direct messages. Enea LINX interprocess communications (IPC) services extend the benefits of message passing to Enea OSEck applications distributed across multiple DSPs. Enea OSE ck provides a simple yet powerful API, whose high level of abstraction typically enables programmers to code the bulk of their application with just eight system calls. This versatile API, together with OSE ck's high-level messaging protocol, reduces application size and complexity, and makes programs easier to maintain, read and understand.

Enea Press Contacts:

Nordic:

Jenny Palmblad
Director of Communications, Enea
Phone: 46 8 507 143 24
Email: jenny.palmblad@enea.com

North America:

Danielle Schwartz Cordingley
Director Product Marketing Communications,
Enea Phone: 1 760 603 9315
Email: danielle.schwartz@enea.com

Jennifer Bingham
Davis Marrin PR
Phone: 1 619 980 4205
Email: jennifer@davismarrin.com

Asia Pacific:

Marcus Hjortsberg
Vice president of software sales Asia, Enea
Phone: 86 21 6334 3406
Email: marcus.hjortsberg@enea.com

Europe:

Benedicte Bissey
Marketing communications manager, Europe, Enea
Phone: 33 1 69 18 14 47
Email: benedicte.bissey@enea.com

CEVA Press Contacts:

Richard Kingston
CEVA, Inc.
Phone: + 1 408-514-2976
Email: richard.kingston@ceva-dsp.com

Mike Sottak
Wired Island, Ltd.
Phone: +1 408-876-4418
Email: mike@wiredislandpr.com

About Enea

Enea (Nordic Exchange/Small Cap/ENEA) is the leading supplier of real-time operating systems, middleware, development tools, database technology and professional services for high-availability systems such as telecommunications infrastructure, mobile devices, medical instrumentation, and

automobile control/infotainment. Enea's flagship operating system, Enea OSE, is deployed in approximately half of the world's 3G mobile phones and base stations. Enea has over 750 employees and is listed on the OMX Nordic Exchange Stockholm AB. For further information on Enea, please visit www.enea.com.

About CEVA, Inc.

Headquartered in San Jose, Calif., CEVA is a leading licensor of silicon intellectual property (SIP) platform solutions and DSP cores for mobile handsets, consumer electronics and storage applications. CEVA's IP portfolio includes comprehensive solutions for multimedia, audio, voice over packet (VoP), Bluetooth and Serial ATA (SATA), and a wide range of programmable DSP cores and subsystems with different price/performance metrics serving multiple markets. In 2007, CEVA's IP was shipped in over 225 million devices. For more information, visit www.ceva-dsp.com/

Enea®, Enea OSE®, Netbricks®, Polyhedra® and Zealcore® are registered trademarks of Enea AB and its subsidiaries. Enea OSE® ck, Enea OSE® Epsilon, Enea® Element, Enea® Optima, Enea® LINX, Enea® Accelerator, Polyhedra® Flashlite, Enea® dSPEED Platform, Accelerating Network Convergence(TM), Device Software Optimized(TM) and Embedded for Leaders(TM) are unregistered trademarks of Enea AB or its subsidiaries. Any other company, product or service names mentioned above are the registered or unregistered trademarks of their respective owner. © Enea AB 2008.